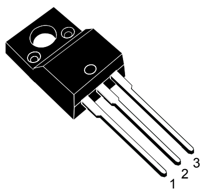
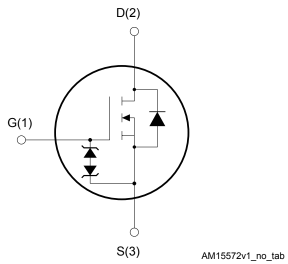
STFU15N80K5

Datasheet

N-channel 800 V, 300 mΩ typ., 14 A MDmesh K5 Power MOSFET in a TO-220FP ultra narrow leads package



TO-220FP
ultra narrow leads



Features

Order code	V_{DS}	$R_{DS(on)}$ max.	I_D
STFU15N80K5	800 V	375 mΩ	14 A

- Industry's lowest $R_{DS(on)}$ x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

- Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Product status link
STFU15N80K5

Product summary	
Order code	STFU15N80K5
Marking	15N80K5
Package	TO-220FP ultra narrow leads
Packing	Tube

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate-source voltage	± 30	V
I_D (1)	Drain current (continuous) at T_C = 25 °C	14	A
I_D (1)	Drain current (continuous) at T_C = 100 °C	8.8	A
I_{DM} (2)	Drain current (pulsed)	56	A
P_{TOT}	Total power dissipation at T_C = 25 °C	35	W
V_{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1 s; T_C=25 °C)	2500	V
dv/dt (3)	Peak diode recovery voltage slope	4.5	V/ns
T_{stg}	Storage temperature range	- 55 to 150	°C
T_J	Operating junction temperature range		

1. *Limited by package.*
2. *Pulse width limited by safe operating area.*
3. *I_{SD} ≤ 14 A, di/dt = 100 A/µs; V_{DS} (peak) < $V_{(BR)DSS}$.*

Table 2. Thermal data

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case	4.17	°C/W
$R_{thj-amb}$	Thermal resistance junction-ambient	62.5	°C/W

Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I_{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T_{jmax})	4	A
E_{AS}	Single pulse avalanche energy (starting T_j = 25 °C, I_D = I_{AR}, V_{DD} = 50 V)	150	mJ

2 Electrical characteristics

T_C = 25 °C unless otherwise specified.

Table 4. On/off-state

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	V_{GS} = 0 V, I_D = 1 mA	800			V
I_{DSS}	Zero gate voltage drain current	V_{GS} = 0 V, V_{DS} = 800 V			1	µA
		V_{GS} = 0 V, V_{DS} = 800 V T_C = 125 °C[(1)]			50	µA
I_{GSS}	Gate body leakage current	V_{DS} = 0 V, V_{GS} = ±20 V			±10	µA
$V_{GS(th)}$	Gate threshold voltage	V_{DS} = V_{GS}, I_D = 100 µA	3	4	5	V
$R_{DS(on)}$	Static drain-source on-resistance	V_{GS} = 10 V, I_D = 7 A		300	375	mΩ

1. *Defined by design, not subject to production test.*

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	V_{DS} = 100 V, f = 1 MHz, V_{GS} = 0 V	-	1100	-	pF
C_{oss}	Output capacitance		-	85	-	pF
C_{rss}	Reverse transfer capacitance		-	1.5	-	pF
$C_{o(tr)}$ [(1)]	Equivalent capacitance time related	V_{DS} = 0 to 640 V, V_{GS} = 0 V	-	113	-	pF
$C_{o(er)}$ [(2)]	Equivalent capacitance energy related		-	49	-	pF
R_g	Intrinsic gate resistance	f = 1 MHz , I_D= 0 A	-	4.5	-	Ω
Q_g	Total gate charge	V_{DD} = 640 V, I_D = 12 A	-	32	-	nC
Q_{gs}	Gate-source charge	V_{GS}= 0 to 10 V	-	6	-	nC
Q_{gd}	Gate-drain charge	(see Figure 15. Test circuit for gate charge behavior)	-	22	-	nC

1. *Time related is defined as a constant equivalent capacitance giving the same charging time as Coss when V_{DS} increases from 0 to 80% V_{DSS}*
2. *Energy related is defined as a constant equivalent capacitance giving the same stored energy as Coss when V_{DS} increases from 0 to 80% V_{DSS}*

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	V_{DD}= 400 V, I_D =7 A, R_G = 4.7 Ω	-	19	-	ns
t_r	Rise time	V_{GS} = 10 V	-	17.6	-	ns
$t_{d(off)}$	Turn-off delay time	see (Figure 14. Test circuit for resistive load switching times and	-	44	-	ns
t_f	Fall time	Figure 19. Switching time waveform)	-	10	-	ns

Table 7. Source-drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{SD}	Source-drain current		-		14	A
I_{SDM} (1)	Source-drain current (pulsed)		-		56	A
V_{SD} (2)	Forward on voltage	I_{SD} = 14 A, V_{GS} = 0 V	-		1.5	V
t_{rr}	Reverse recovery time	I_{SD} = 14 A, di/dt = 100 A/µs,V_{DD} = 60 V (see Figure 16. Test circuit for inductive load switching and diode recovery times)	-	445		ns
Q_{rr}	Reverse recovery charge		-	8.2		µC
I_{RRM}	Reverse recovery current		-	37		A
t_{rr}	Reverse recovery time	I_{SD} = 14 A, di/dt = 100 A/µs V_{DD} = 60 V, T_j = 150 °C (see Figure 16. Test circuit for inductive load switching and diode recovery times)	-	580		ns
Q_{rr}	Reverse recovery charge		-	10		µC
I_{RRM}	Reverse recovery current		-	35		A

1. *Pulse width limited by safe operating area*
2. *Pulsed: pulse duration = 300 µs, duty cycle 1.5%*

Table 8. Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)GSO}$	Gate-source breakdown voltage	I_{GS}= ± 1mA, I_D= 0 A	30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection,thus eliminating the need for additional external componentry.

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

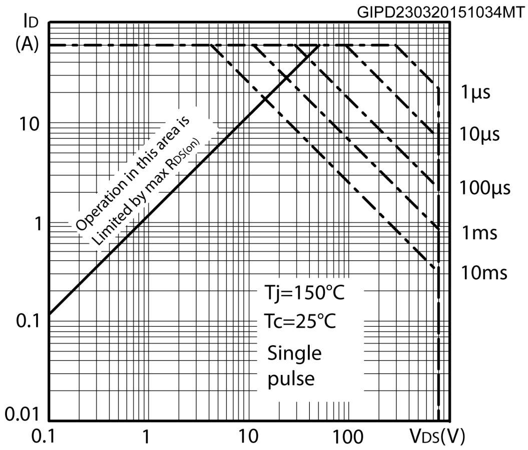


Figure 2. Thermal impedance

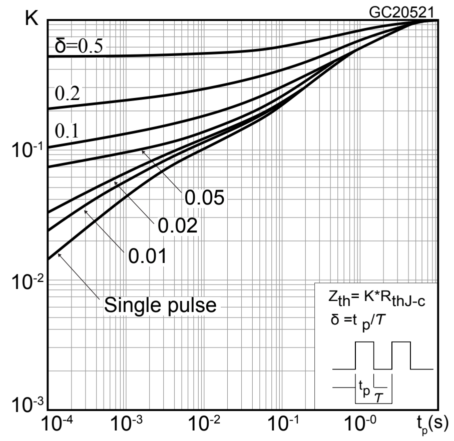


Figure 3. Output characteristics

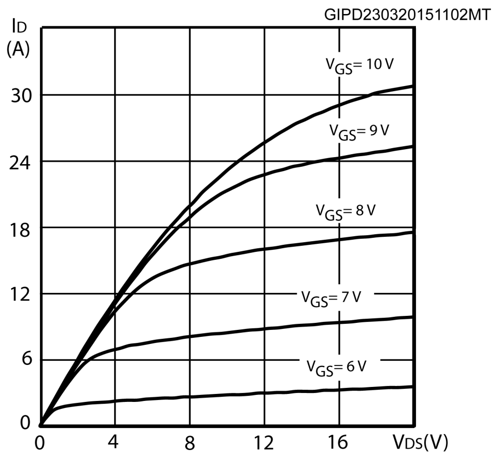


Figure 4. Transfer characteristics

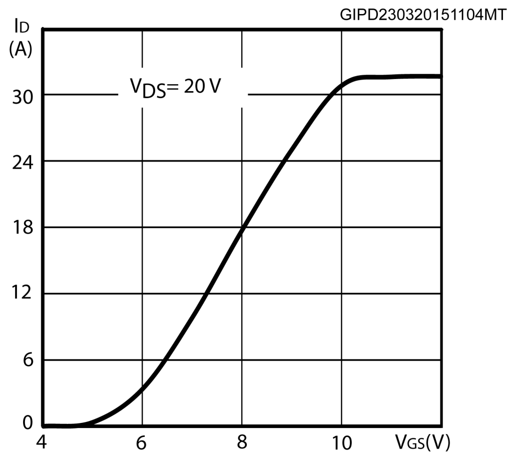


Figure 5. Gate charge vs gate-source voltage

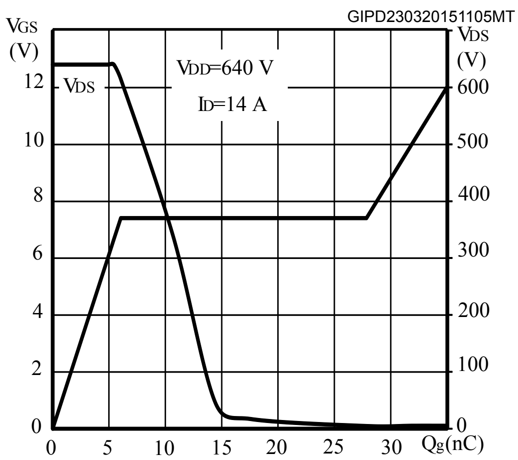


Figure 6. Static drain-source on-resistance

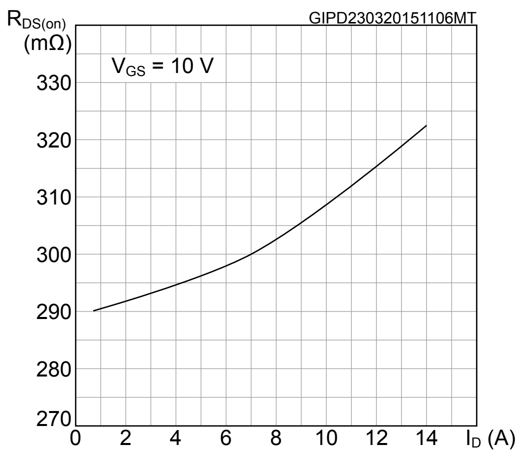


Figure 7. **Capacitance variations**

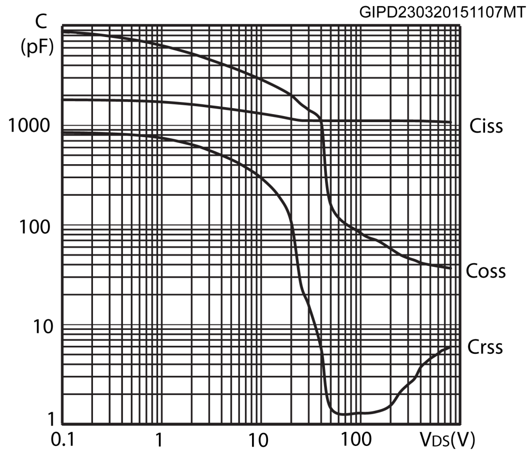


Figure 8. **Source-drain diode forward characteristics**

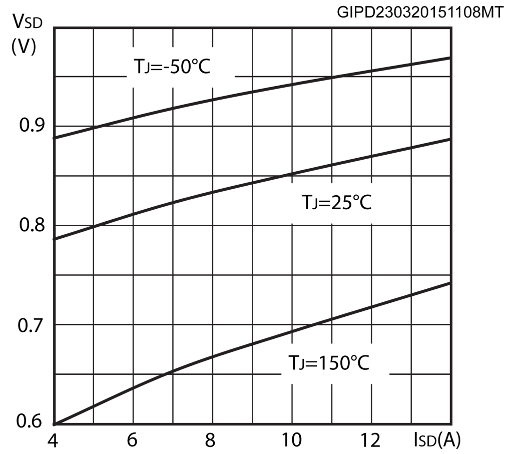


Figure 9. **Normalized gate threshold voltage vs temperature**

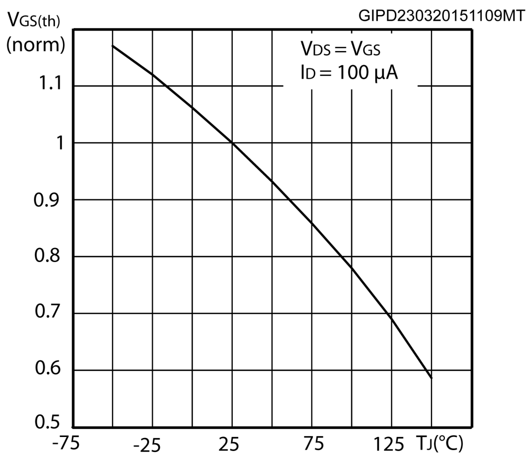


Figure 10. **Normalized on-resistance vs temperature**

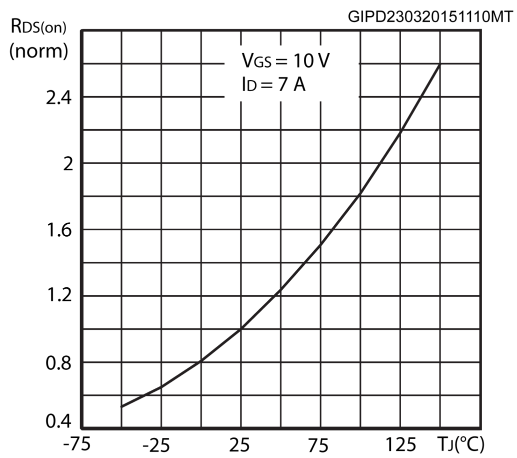


Figure 11. **Output capacitance stored energy**

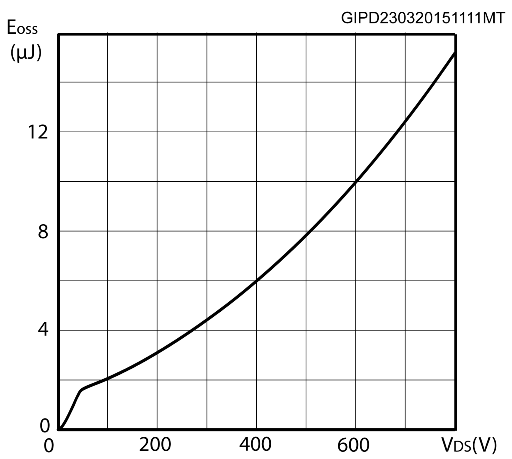


Figure 12. **Normalized V_{DS} vs temperature**

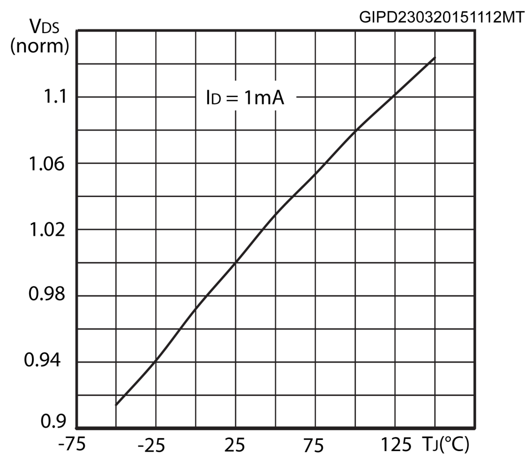
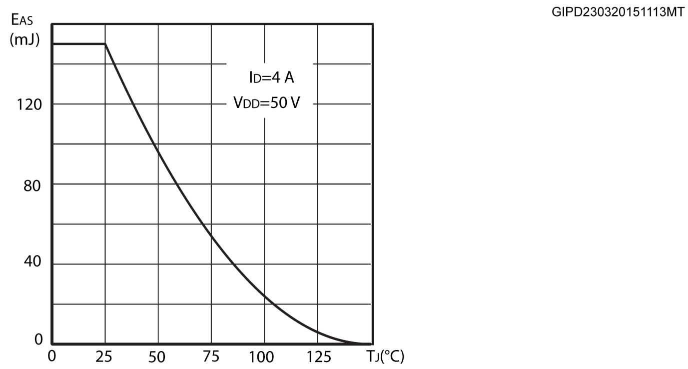


Figure 13. Maximum avalanche energy vs temperature



3 Test circuits

Figure 14. Test circuit for resistive load switching times

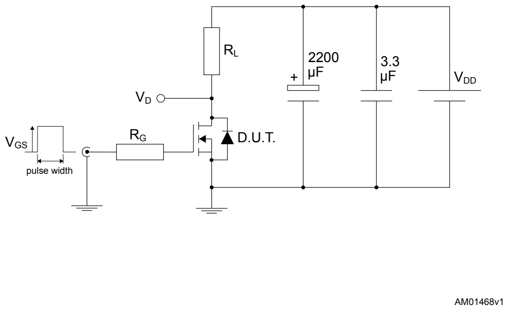


Figure 15. Test circuit for gate charge behavior

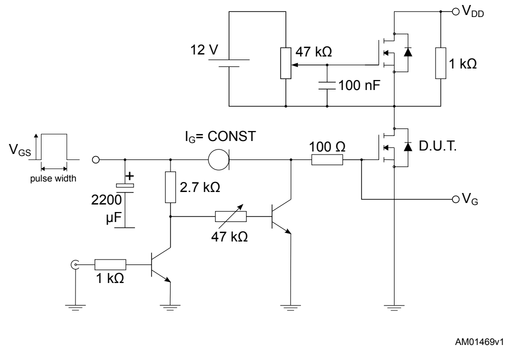


Figure 16. Test circuit for inductive load switching and diode recovery times

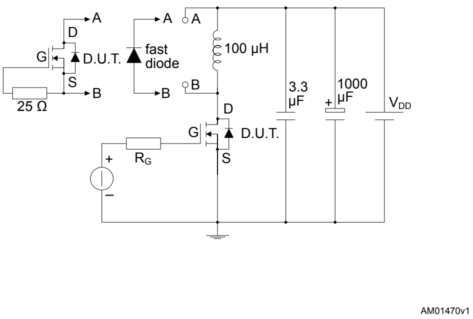


Figure 17. Unclamped inductive load test circuit

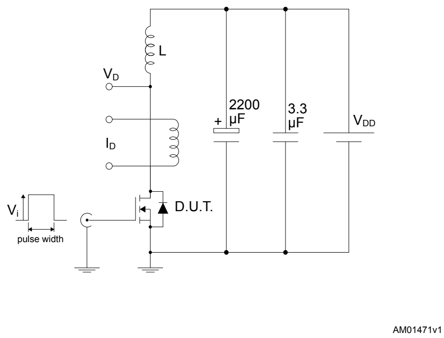


Figure 18. Unclamped inductive waveform

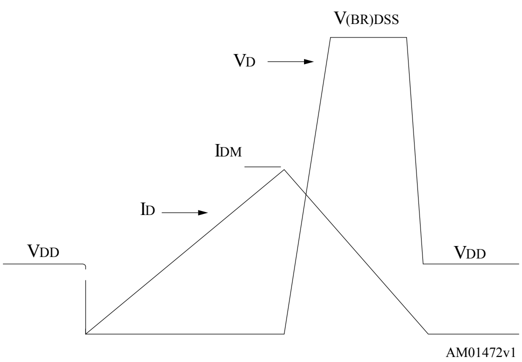
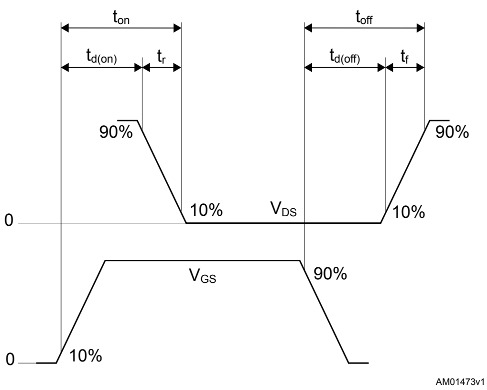


Figure 19. Switching time waveform



4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

4.1 TO-220FP ultra narrow leads package information

Figure 20. TO-220FP ultra narrow leads package outline

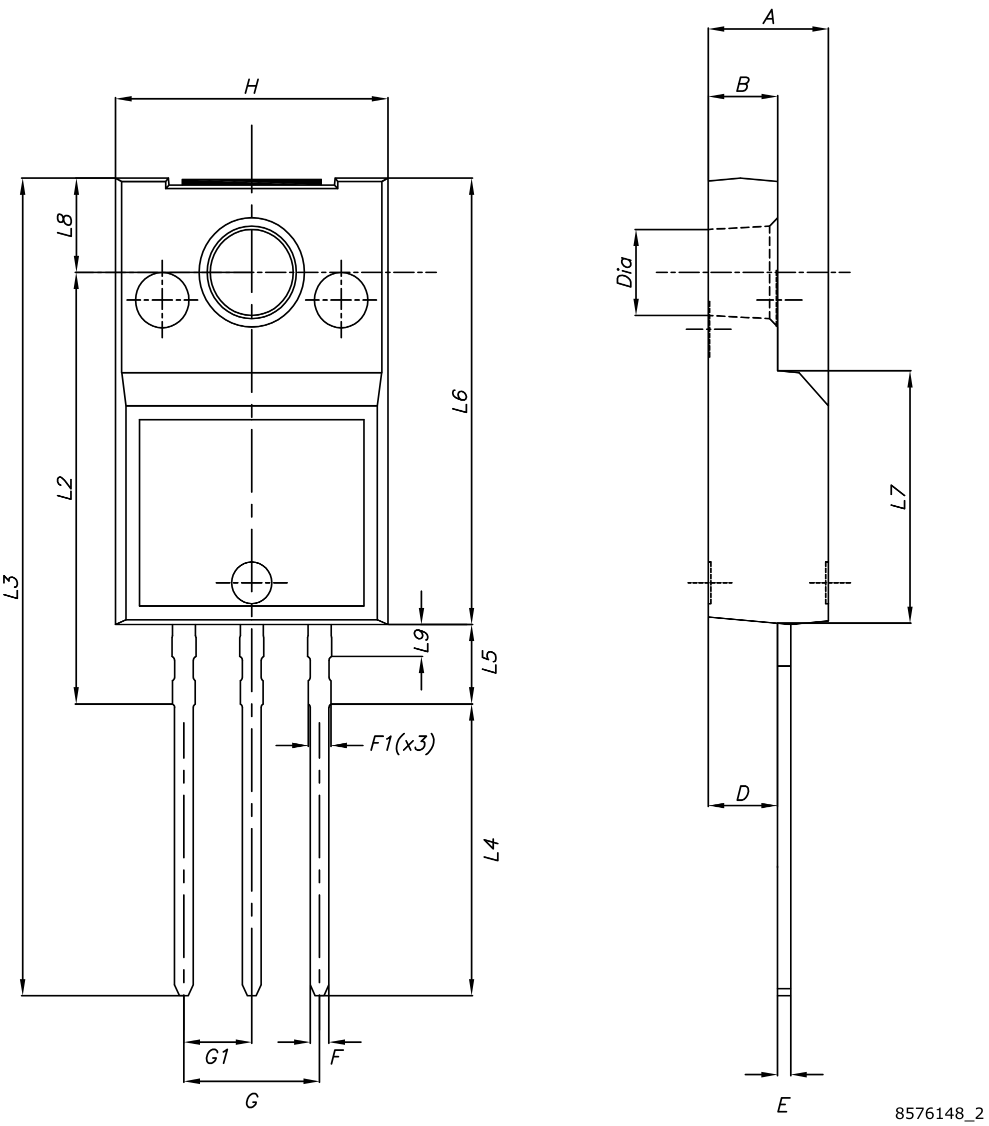


Table 9. TO-220FP ultra narrow leads mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
B	2.50		2.70
D	2.50		2.75
E	0.45		0.60
F	0.65		0.75
F1	-		0.90
G	4.95		5.20
G1	2.40	2.54	2.70
H	10.00		10.40
L2	15.10		15.90
L3	28.50		30.50
L4	10.20		11.00
L5	2.50		3.10
L6	15.60		16.40
L7	9.00		9.30
L8	3.20		3.60
L9	-		1.30
Dia.	3.00		3.20

Revision history

Table 10. Document revision history

Date	Revision	Changes
13-Apr-2015	1	Initial release.
09-Sep-2015	2	Text and formatting changes throughout document Datasheet status promoted from preliminary to production data
15-May-2020	3	Updated internal schematic diagram on cover page. Modified Figure 6. Static drain-source on-resistance . Updated Section 4.1 TO-220FP ultra narrow leads package information. Minor text changes.

Contents

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